AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions and listings of claims in the application:

LISTING OF CLAIMS:

Claim 1. (currently amended): An antistatic vinyl chloride resin molding, which comprises a base layer comprising a vinyl chloride resin, an intermediate layer and an antistatic layer containing a conductive material and being laminated on at least one side of said base layer, wherein the base layer comprises from 5 to 50 parts by weight of a titanium compound and 100 parts by weight of a vinyl chloride resin, wherein the thickness of the base layer is from 1 to 15 mm, and the intermediate layer comprises a vinyl chloride resin having a chlorination degree of from 58 to 73% and has a composition different from that of the base layer, wherein the thickness of the intermediate layer is from 30 to ~~500~~350 μm.

Claim 2. (currently amended): An antistatic vinyl chloride resin molding, which comprises a base layer comprising a vinyl chloride resin, an intermediate layer and an antistatic layer containing a conductive material and being laminated on at least one side of said base layer, wherein said base layer comprises a vinyl chloride resin having a chlorination degree of from 58 to 73%, wherein the thickness of the base layer is from 1 to 15 mm and the intermediate layer comprises a vinyl chloride resin having a chlorination degree of from 58 to 73% and has a composition different from that of the base layer, wherein the thickness of the intermediate layer is from 30 to ~~500~~350 μm.

Claim 3. (canceled).

Claim 4. (currently amended): An antistatic vinyl chloride resin molding, which comprises a base layer comprising a vinyl chloride resin, an intermediate layer and an antistatic layer containing a conductive material and being laminated on at least one side of said base layer, wherein said base layer comprises 100 parts by weight of a vinyl chloride resin having a chlorination degree of less than 58% and from 0.1 to 2.5 parts by weight of a molybdenum compound, wherein the thickness of the base layer is from 1 to 15 mm, and the intermediate layer comprises a vinyl chloride resin having a chlorination degree of from 58 to 73% and has a composition different from that of the base layer, wherein the thickness of the intermediate layer is from 30 to ~~500~~350 μm.

Claims 5-16. (canceled).

Claim 17. (currently amended): An antistatic vinyl chloride resin molding, which comprises a base layer comprising a vinyl chloride resin, an intermediate layer and an antistatic layer containing a conductive material and being laminated on at least one side of said base layer, wherein the base layer comprises a vinyl chloride resin having a chlorination degree of from 58 to 73%, wherein the thickness of the base layer is from 1 to 15 mm, and the intermediate layer has a thickness of less than 200 μm, does not contain a titanium ~~oxide~~compound, comprises a vinyl chloride resin having a chlorination degree of less than 58% and has a composition different from that of the base layer.

Claim 18. (canceled).

Claim 19. (previously presented): The antistatic vinyl chloride resin molding according to any one of claims 1, 2, 4 or 17, wherein the antistatic layer comprises, as a binder resin, a vinyl chloride resin having a chlorination degree of from 58 to 73%, and a conductive material.

Claim 20 (previously presented): The antistatic vinyl chloride resin molding according to any one of claims 1, 2 or 17, wherein the antistatic layer comprises, as a binder resin, an ultraviolet curing or thermosetting resin, and a conductive material.

Claim 21. (previously presented): The antistatic vinyl chloride resin molding according to any one of claims 1, 2 or 17, wherein the conductive material is at least one of tin oxide, a conductive titanium oxide, and a twisting and entangling ultra thin long carbon fiber.

Claim 22. (previously presented): The antistatic vinyl chloride resin molding according to claim 17, wherein the thickness of the intermediate layer is from 25 to 150 μm.

Claim 23. (previously presented): An antistatic vinyl chloride resin molding, which comprises a transparent base layer comprising a vinyl chloride resin having a chlorination degree of from 58 to 73% and a tin system heat stabilizer, wherein the thickness of the base layer is from 1 to 15 mm, an intermediate layer having a thickness of from 50 to 350 μm, comprising a vinyl chloride resin having a chlorination degree of from 58 to 73% and having a composition different from that of the base layer, and an antistatic surface layer having a thickness of from 0.3 to 1.5 μm and containing a conductive material, wherein the conductive material is at least one of tin oxide and a conductive titanium oxide, wherein it has a total light transmittance of 62% or more and a haze value of 8.3% or less when its thickness is 3.3mm.

Claim 24. (new): An antistatic vinyl chloride resin molding, which comprises a transparent base layer of a thickness of 1 to 15 mm comprising a vinyl chloride resin of a chlorination degree of 58 to 73% and a tin based stabilizing agent, an intermediate layer of a thickness of 50 to 350 μm utilizing a vinyl chloride resin of a chlorination degree of 58 to 73% and having a composition different from that of the base layer, and an antistatic surface layer utilizing long carbon fibers as a conductive material and having a thickness of 0.1 to 1.0 μm, wherein a total light transmittance is 40% or higher and a haze value is 60% or lower at a thickness of about 3 mm.